



TEST REPORT IEC 60335-2-32 Safety of household and similar electrical appliances Part 2: Particular requirements for massage appliance Report Reference No. GZES120200117903 Date of issue 2012-07-11 SGS-CSTC Standards Technical Services Co., Ltd. - E&E Lab CB Testing Laboratory..... Guangzhou 198 Kezhu Road, Scientech Park, Guangzhou Economic & Address: Technology Development District, Guangzhou, Guangdong, China 510663 Applicant's name..... HoMedics Group Ltd HoMedics House, Somerhill Business Park, Five Oak Green Road, Address Tonbridge, Kent TN11 0GP England **Test specification:** Standard..... IEC 60335-2-32:2002 (Fourth edition) + A1 :2008 used in conjunction with IEC 60335-1:2001 (Fourth Edition) + A1 : 2004 + A2: 2006 Test procedure SGS-CSTC Non-standard test method.....: N/A Test Report Form No. IEC60335_2_32E Test Report Form(s) Originator: LCIE Master TRF Dated 2009-05 Copyright © 2009 IEC System for Conformity Testing and Certification of Electrical Equipment (IECEE), Geneva, Switzerland. All rights reserved. This publication may be reproduced in whole or in part for non-commercial purposes as long as the IECEE is acknowledged as copyright owner and source of the material. IECEE takes no responsibility for and will not assume liability for damages resulting from the reader's interpretation of the reproduced material due to its placement and context. If this Test Report Form is used by non-IECEE members, the IECEE/IEC logo and the reference to the CB Scheme procedure shall be removed. This report is not valid as a CB Test Report unless signed by an approved CB Testing Laboratory and appended to a CB Test Certificate issued by an NCB in accordance with IECEE 02. Test item description: Massage chair (Shiatsu Gel Massage Cushion w/ Heat) Trade Mark: HOMEDICS Manufacturer Model/Type reference SGM-425H-EU, GSM-400H-GB Ratings 220 V – 240 V; 50 Hz / 60 Hz; 35 W; Class II Factory: —



Testing procedure and testing location:			
CB Testing Laboratory:	SGS-CSTC Standards Technical Services Co., Ltd E&E Lab Guangzhou		
Testing location/ address:	198 Kezhu Road, Scientech Park, Guangzhou Economic & Technology Development District, Guangzhou/Guangdong, China 510663		
Associated CB Laboratory:	N/A		
Testing location/ address:			
Tested by (name + signature):	Byron Chingman chi		
Approved by (+ signature):	Nick Cui Vick (rui		
Testing procedure: TMP	N/A		
Tested by (name + signature):			
Approved by (+ signature):			
Testing location/ address:			
Testing procedure: WMT	N/A		
Tested by (name + signature):			
Witnessed by (+ signature):			
Approved by (+ signature):			
Testing location/ address:			
Testing procedure: SMT	N/A		
Tested by (name + signature):			
Approved by (+ signature):			
Supervised by (+ signature):			
Testing location/ address:			
Testing procedure: RMT	N/A		
Tested by (name + signature):			
Approved by (+ signature):			
Supervised by (+ signature):			
Testing location/ address:			

Summary of testing:				
Tests performed (name of test and test clause): Tests according to the following standards were carried out: BS EN / EN 60335-1: 2002 + A11: 2004 + A1: 2004 + A12: 2006 + A2: 2006 + A13: 2008 + A14: 2010 + A15: 2011 BS EN / EN 60335-2-32: 2003 + A1: 2008 BS EN / EN 62233: 2008 After reviewed, no test was considered. The submitted samples fulfil the requirements of the standards.	Testing location: See page one			
Summary of compliance with National Differences	5:			
Copy of marking plate				
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Test item particulars	:	_			
Classification of installation and use	:	Portable appliance			
Supply Connection	:	Non-detachable powe	er cord fitted with plug		
Possible test case verdicts:					
- test case does not apply to the test object	:	N/A			
- test object does meet the requirement	:	P (Pass)			
- test object does not meet the requirement	:	F (Fail)			
Testing	:				
Date of receipt of test item	:	2012-07-09			
Date (s) of performance of tests	:	2012-07-09 to 2012-0)7-11		
General remarks:					
The test results presented in this report relate only This report shall not be reproduced, except in full, "(see Enclosure #)" refers to additional informatio "(see appended table)" refers to a table appended	witho	ut the written approval pended to the report.	l of the Issuing testing laboratory.		
Throughout this report a comma is used as the c	decima	al separator.			
This document is issued by the company under i <u>http://www.sgs.com/terms_and_conditions.htm</u> . indemnification and jurisdiction issues defined th	Atten	tion is drawn to the lir			
Any holder of this document is advised that inform at the time of its intervention only and within the responsibility is to its Client and this document do all their rights and obligations under the transact falsification of the content or appearance of this of the fullest extent of the law.	limits loes no ion do	of Client's instructions ot exonerate parties to ocuments. Any unauth	s, if any. The Company's sole o a transaction from exercising porized alteration, forgery or		
Unless otherwise stated: (a) the results shown in this document refer only to the sample(s) tested and (b) such sample(s) are retained for 12 months. This document cannot be reproduced except in full, without prior approval of the company.					
Test report Ref. No. GZES120200117903, dated GZES120200117902 and GZES120200117901.	d 2012	2-07-11 is not valid w	ithout test report		
This test report includes the following addition	onal d	locuments to origina	al TRF:		
Annex I: circuit diagram; Annex II: Photo documentation.					
General product information: Shiatsu Gel Massage Cushion w/ Heat for househ The model SGM-425H-EU and GSM-400H-GB ar 400H-GB uses BS PLUG. PO No.: PC0000959			iH-EU uses EU plug, GSM-		
Amendment-1:					
The original Test Report Ref. No. GZES1202001 ⁻⁷ include the following modifications: 1 Added shiatsu select speed function and Chang More details see circuit diagram attachment and p PO No.: PC0001037	ged co	ntrol function circuit di			

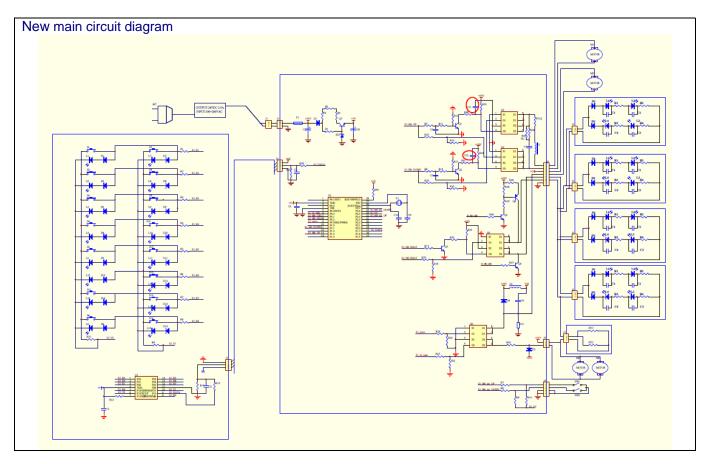
Amendment-2:

The original Test Report Ref. No. GZES120200117902, Dated 2012-06-06 was modified on 2012-07-11 to include the following modifications: 1. Modification the main circuit diagram;

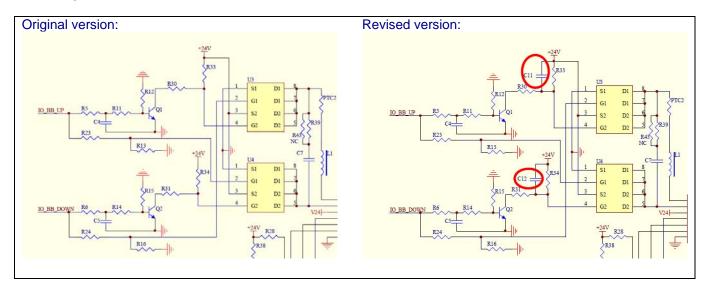
2. Modification the PCB layout.



Circuit diagram documentation

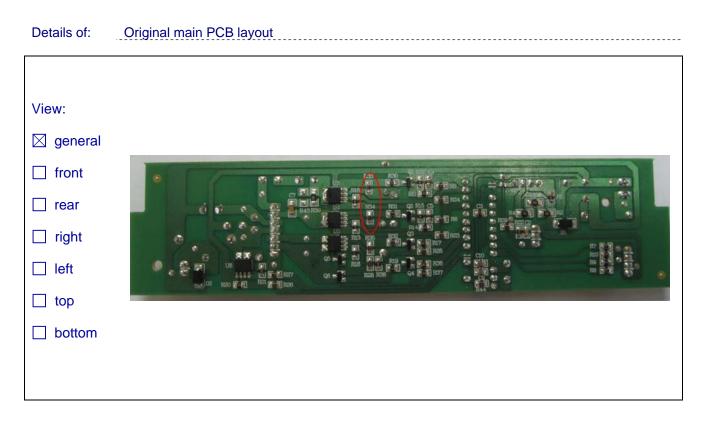


Different point

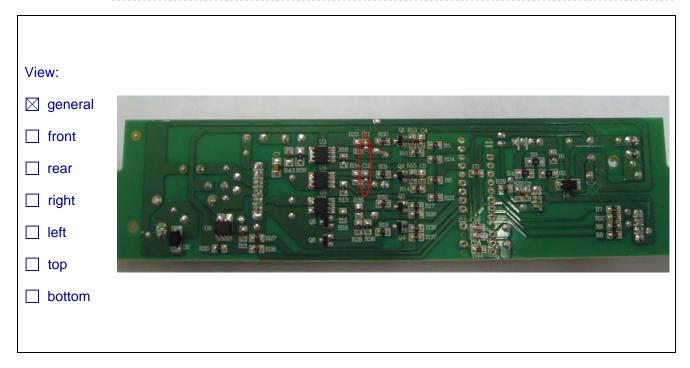


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Details of: Revised main PCB layout



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